

RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS1643 (w/BR1225)	Feb-96	9606 B2	DALLAS	DA074753AAA	N/A	28 MODULE

STRESS/JOB NO.

READPOINT

(Sample Size/No. of Fails)

Hi Temp Storage 70°C, No Bias P-16961, P-16971	<u>0 Hr</u>	<u>336 Hr</u>	<u>1K Hr</u>	<u>Elect. Test</u>	<u>Cum %</u>
	90/0	20/0	20/0	20/0	0.0%

Temp Cycle 0°C to +70°C P-16972	<u>300 ~</u>	<u>1K ~</u>	<u>Elect. Test</u>	<u>Cum %</u>
	35/0	35/0	35/0	0.0%

Moisture Soak 60°C/90% RH P-16973	<u>288 Hr</u>	<u>960 Hr</u>	<u>Elect. Test</u>	<u>Cum %</u>
	35/0	35/0	35/0	0.0%

Phys. Dimen. <u>P-16624</u> 6/0

Solderability <u>P-16623</u> 24/0

Failure Mode

Failure Analysis